



(1.27 mm) .050"

# IICRO BOARD STACKER

### **SPECIFICATIONS**

For complete specifications see www.samtec.com?DWM or www.samtec.com?HDWM

Insulator Material:

Terminal Material: Phosphor Bronze

Phosphor Biorize
Plating:
Au or Sn over
50 µ" (1.27 µm) Ni
Operating Temp Range:
-55 °C to +105 °C with Tin
-55 °C to +125 °C with Gold

**RoHS Compliant:** 

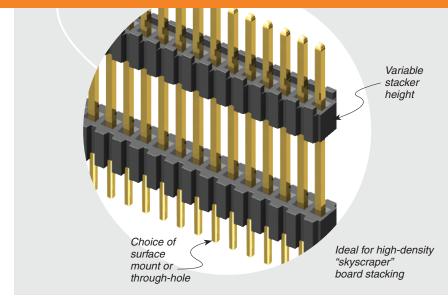
### **PROCESSING**

Lead-Free Solderable:

Yes SMT Lead Coplanarity: (0.15 mm) .006" max\* (.004" stencil solution may be available; contact IPG@samtec.com)

#### Mates with:

SMS, SLM, RSM



**ROW** 

OPTION

-S

= Single

Row

STACKER

**HEIGHT** 

-"XXX"

= Stacker

Height

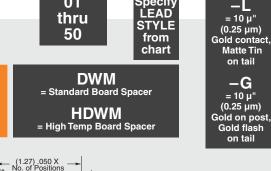
Example:

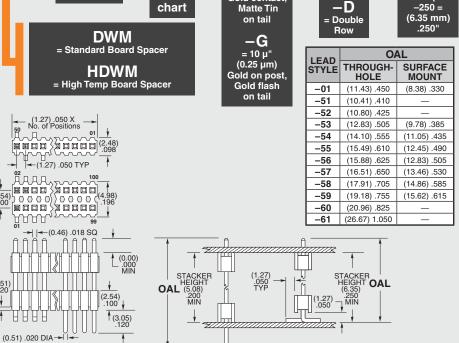
### RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



### **TYPE** NO. PINS **LEAD STRIP PER ROW** STYLE Specify LEAD 01 thru **STYLE** 50 from chart **DWM** = Standard Board Spacer HDWM





**PLATING** 

**OPTION** 

## **OTHER OPTION**

# "XXX"

= Polarized Position (Specify position of omitted pin)

# -SM

= Surface Mount (Requires HDWM. 02 thru 40 positions only.)

### -A

= Alignment Pin (Requires HDWM. 6 positions min -D only.)
Metal or plastic at
Samtec discretion (N/A with -LC)

### – LC

= Locking Clip (Requires HDWM. (5 positions min. -D only) (N/A with -A) (Mànual placement required)

– P = Pick & Place Pad (Requires HDWM)

### Notes:

For added mechanical stability, Samtec recommends mechanical board spacers be used in applications with gold or selective gold plated connectors. Contact ipg@samtec.com for more information.

ALSO AVAILABLE

(MOQ Required)

Other platings

This Series is non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice